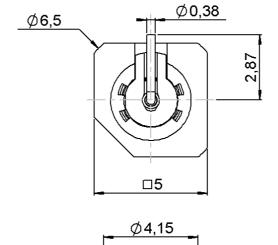
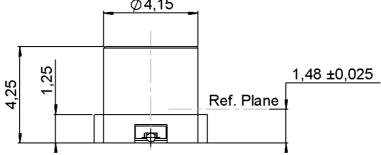
# R222.941.300

#### LIMITED DETENT-TAPE AND REEL BY 500

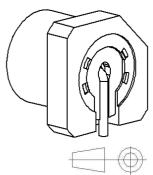
Series : **SMP-COM** 







All dimensions are in mm.



_	COMPONENTS	MATERIALS	PLATING (μm)
	BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	BRASS BRASS - PEEK	NPGR NPGR - - -

**Issue:** 1316 C

In the effort to improve our products, we reserve the right to make changes judged to be



## R222.941.300

#### LIMITED DETENT-TAPE AND REEL BY 500

Series: SMP-COM

#### **PACKAGING**

Standard	Unit	Other
500		Contact us

#### **SPECIFICATION**

#### **ELECTRICAL CHARACTERISTICS**

Impedance **50** Ω Frequency **0-12.4\*** GHz

**VSWR 1.10\*\*** + **0.0000** x F(GHz) Maxi

Insertion loss **0.12**  $\sqrt{F(GHz)}$  dB Maxi **NA** - F(GHz)) dB Maxi RF leakage

Voltage rating 335 Veff Maxi Dielectric withstanding voltage 500 Veff mini Insulation resistance **5000** MΩ mini

#### **ENVIRONMENTAL**

-55/+125 ° C Operating temperature

Hermetic seal NA Atm.cm3/s

Panel leakage NA

#### **OTHER CHARACTERISTICS**

Assembly instruction NA

Others:

\* ROS 1.35 at 12.4GHz

\*\*ROS at 6GHz

### **MECHANICAL CHARACTERISTICS**

Center contact retention

Axial force – Mating end **6.8** N mini **6.8** N mini Axial force – Opposite end Torque NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

Weight **0,3310** g

**Issue:** 1316 C

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# R222.941.300

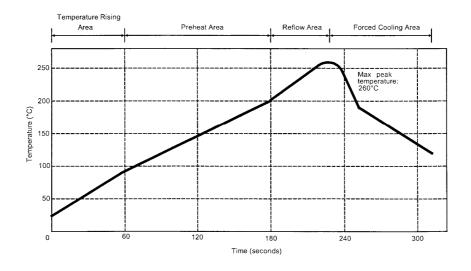
#### LIMITED DETENT-TAPE AND REEL BY 500

Series: SMP-COM

#### **SOLDER PROCEDURE**

- 1. Deposit solder paste 'SnAg4Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
  - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged .
- 5. Verification of solder joints and position of the component by visual inspection.

#### TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

 $\begin{tabular}{ll} \textbf{Issue:} 1316 & C \\ \textbf{In the effort to improve our products, we reserve the right to make changes judged to be} \\ \end{tabular}$ 



# R222.941.300

## Series: SMP-COM

## LIMITED DETENT-TAPE AND REEL BY 500

# COPLANAR LINE

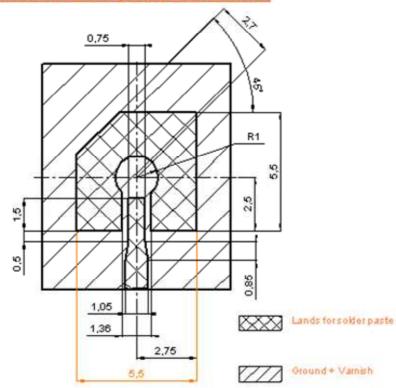
Pattern and signal are on the same side.

Thickness of PCB: 1.6mm

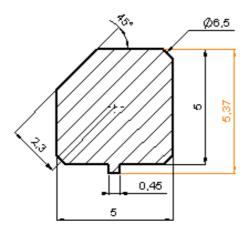
The material of PCB is the epoxy resin of glass fabrics bacs (ER:4.8).

The solder resist should be printed exept for the land pattern on the PCB.

### STANDARD PAD(For ROGERS 4350)



#### SHADOW OF RECEPTACLE FOR VIDEO CAMERA



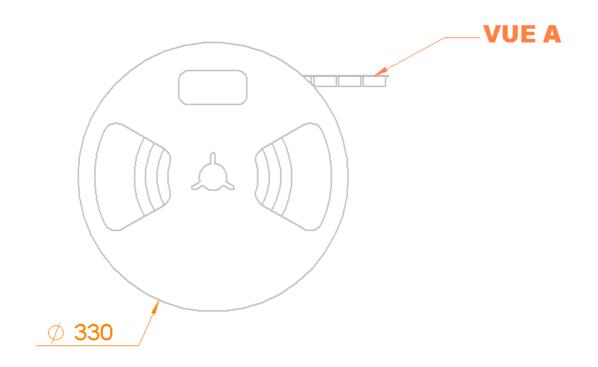
**Issue:** 1316 C
In the effort to improve our products, we reserve the right to make changes judged to be necessary.



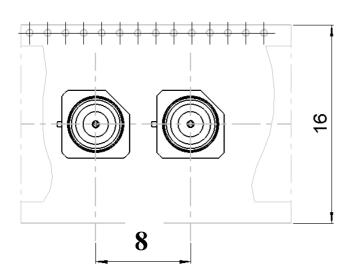
### LIMITED DETENT-TAPE AND REEL BY 500

# R222.941.300

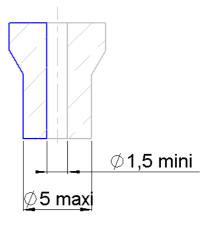
Series: SMP-COM



### Vue suivant A



## **AIR SUNCTION**



**Issue:** 1316 C
In the effort to improve our products, we reserve the right to make changes judged to be



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